



RD50 Acceptor Removal Project and Defect Characterization at CERN

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Motivation

'Acceptor removal':

 Apparent de-activation of B as a shallow dopant with fluence leading to the change of V_{dep} and N_{eff} on the macroscopic level

Macroscopic studies:

'Acceptor removal' is observed in sensors mainly as a shift of V_{dep} obtained from CV measurements



G. Kramberger et al, VERTEX (2016)

Fast timing sensors:

• LGAD (Low Gain Avalanche Detector)



Gain of these sensors decreases with exposure to the radiation due to the 'acceptor removal'





Motivation

'Acceptor removal':

Originated from B_iO_i complex formation on the microscopic level







Figure 3.8: Hierarchy and stability of self-interstitial related defects as function of temperature. For annealing parameters and references see Tab. B.1.

- B and C competing for interstitials
- High *ρ* Si: O≫C≫B leading to the production of mainly CiOi



TSC measurement on defects produced by 23 MeV protons





Motivation

Parameterisation as

 $N_{\text{eff}}(\boldsymbol{\Phi}) = N_{\text{CO}} \exp(-c\boldsymbol{\Phi})$

with (often) complete acceptor removal ($N_{CO} = N_{eff,O}$) for proton and incomplete - for neutron irradiation

Geneva, P. Almeida et al, 32nd RD50 workshop (2018) Workshop, /ana Gurimskaya, 33rd

CERN,

26-28 of November, 2018,



K. Kaska (2014) http://repositum.tuwien.ac.at/obvutwhs/content/titleinfo/1633435 A. Affolder et al. (2016) https://doi.org/10.1088/1748-0221/11/04/P04007 E. Cavallaro et al. (2017) https://doi.org/10.1088/1748-0221/12/01/C01074 B. Hiti et al. (2017) https://doi.org/10.1088/1748-0221/12/10/P10020 I. Mandić et al. (2017) https://doi.org/10.1088/1748-0221/12/02/P02021 P. Dias de Almeida (2017) https://indico.cern.ch/event/637212/ G. Kramberger (2017) https://indico.cern.ch/event/577879/ M. Moll (2018) https://doi.org/10.1109/TNS.2018.2819506

Solution: dedicated defect and material characterization experiment

A large number of simple test structures with known B content in order to concentrate on the bulk features: unify list of the defects and their impact on sensor properties including introduction rates and annealing behaviour for different types of irradiations and materials







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Detector Technologies

EP-DT



Acceptor **Removal** project: materials and samples

In the framework of RD50 collaboration





EP-DT **Detector Technologies**

2,5 mm

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Irradiation Campaign and Distribution

In the framework of the Acceptor Removal project



Status of TSC measurements at CERN

Proton vs Neutron irradiation

Preliminary TSC results, irradiation type and fluence dependence

Filling conditions variation

Filling temperature dependence and field-enhanced behaviour of TSC spectra

Annealing study

Isothermal annealing study on p-type EPI proton irradiated small pad diodes, Neff vs fluence by TSC measurements

Summary and Outlook

Future plans





Experimental Details

Materials:

Standard EPI Resistivity $\rho \sim 50, 250 \text{ or } 1000 \Omega \cdot \text{cm}$ EPI layer 50 µm Substrate under EPI layer 0-255 µm

p-type Si pad diodes produced by CiS (Erfurt, Germany):

Pad area *A*: $2.5 \times 2.5 \text{ mm}^2$ with guard rings Passivated with openings for connection, window opening on FS and BS for light injection Active thickness *d*: 50 µm in this particular case

Irradiation:

PS protons (CERN): fluences 7.8E13 and 3.32E14 n_{eq}/cm^2 Reactor neutrons (Ljubljana): fluences 7.8E13 and 3.32E14 n_{eq}/cm^2

Microscopic measurements:

TSC (Thermally Stimulated Current) technique: colling ($250K^{\bullet}$ 20K) under -100V, trap filling with 1 mA forward current during 60 sec, ramping up to 250K under reverse bias (standard -100V but can vary) with constant heating rate β =11 K/min

Macroscopic measurements:

IV and CV measurements @ +20 and -20 °C, guard ring connected to the ground (analysis of data in progress)





Geneva,





Proton vs Neutron irradiation (ϕ =7.8E18 n_{eq}/cm²). spectra

+SC

Annealing: 10 min @60°C

TSC



Comparison of TSC spectra measured on **proton** and **neutron** irradiated with fluence 7.8E13 n_{eq}/cm^2 thin EPI Si pad diodes with different resistivity.





Filling Temperature variation. Protons (ϕ =3.32E14 n_{eq}/cm²)



Peak height of the TSC signal in dependence of the filling temperature T_{fill} =>strong dependence of the peak height for E(30), H(40), H(140-152), V₂ is observed =>can be governed by fractional occupation of the defect or T-dependent capture cross section σ





Bias Voltage variation. Protons (ϕ =3.32E14 n_{eq}/cm²)



TSC spectra and temperature shift in the peak position due to the variation of the bias voltage => Poole-Frenkel effect





Proton vs Neutron irradiation. TSC comparison



Fluence and particle type dependance of TSC spectra measured on thin EPI Si pad diodes with 250 ohm.cm resistivity





Proton vs Neutron irradiation. Defect concentration



Concentration of the defects B_iO_i and E(30), H(40), B_iO_i and clusters vs resistivity and type of irradiation





Isothermal Annealing @60°C. Protons

Annealing evolution of the TSC spectra and defects concentration in p-type EPI silicon sensors obtained by TSC spectroscopy method due to the proton irradiation with two different fluences: $7.8E13 n_{eq}/cm^2$ and $3.32E14 n_{eq}/cm^2$.







Isothermal Annealing @60°C. Protons

Evolution of the defects concentrations normalized by fluence in p-type EPI silicon sensors obtained by TSC spectroscopy method due to the proton irradiation with two different fluences of 7.8E13 n_{eq}/cm^2 and 3.32E14 n_{eq}/cm^2 with isothermal annealing. Comparison with the results on annealing study of LGADs.





26-28 of November, 201

Workshop,

TSC workstation

>10 000 hours of working time







sudden loss of cooling power



to Advanced Research Systems







Summary and Outlook

- A new acceptor removal measurement campaign was started within four RD50 research centers - CERN, Hamburg University, NIMP Magurele/Bucharest and University of Minsk: irradiations and distribution of the samples are on the way, first data are presented or will be presented in the workshop
- Strong dependence between B_iO_i production and the resistivity was detected for both proton and neutron irradiation
- First thermal annealing studies show that B_iO_i does not anneal @60°C (max 640 min), which is coherent with the annealing study results on LGADs: the gain is not affected by the annealing
- Further measurements should be performed for additional fluences and other materials Cz and Fz. Additional TSC with red light illumination, determination of the signatures for other observed defects should be obtained to complete existing result. Comparison with macroscopic measurements is on its way

















Acceptor removal

•Apparent dopant removal due to the irradiation

Parameterization as

$$N_{eff}(\Phi) = N_{eff0} \cdot e^{-c \cdot \Phi} + g_c \Phi$$

• For neutron irradiation, incomplete acceptor removal is also considered ($N_c < N_{eff0}$)

$$N_{eff}(\Phi) = N_{eff0} - N_c \left(1 - e^{-c\Phi}\right) + g_c \Phi$$

However, simulations can produce similar Vdep data without changing the background doping concentration (Double junction effect).

> Simulation can qualitatively reproduce this behaviour without Boron removal





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2.0x10¹⁴ 4.0x10¹⁴ 6.0x10¹⁴ 8.0x10¹⁴ 1.0x10¹⁵

Fluence (neq/cm^2)

0.0



Isothermal Annealing @60°C. Protons







Isothermal Annealing @60°C. Protons







Annealing Study Interpretation of Neff

Data

Interpretation of the data assuming type inversion



- Annealing at 60°C
- Up to 20480 min or ~14 days of accumulated annealing
- Neff calculated from CV measurements